

## N and P-Channel Enhancement Mode Power MOSFET



The NCE30NP1812K uses advanced trench technology to provide excellent  $R_{DS(ON)}$  and low gate charge . The complementary MOSFETs may be used to form a level shifted high side switch, and for a host of other applications.

### **General Features**

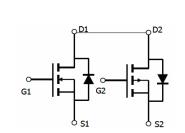
#### N-Channel

 $V_{DS} = 30V, I_D = 18A$  $R_{DS(ON)} < 41m\Omega @ V_{GS} = 10V$  $R_{DS(ON)} < 54m\Omega @ V_{GS} = 4.5V$ 

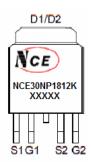
#### • P-Channel

$$\begin{split} V_{DS} =& -30 V, I_D = -12 A \\ R_{DS(ON)} <& 58 m \Omega @ V_{GS} =& -10 V \\ R_{DS(ON)} <& 85 m \Omega @ V_{GS} =& -4.5 V \end{split}$$

- High power and current handing capability
- Lead free product is acquired
- Surface mount package



Schematic diagram



Marking and pin assignment

### 100% UIS TESTED!

#### 100% ΔVds TESTED!

### Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE30NP1812K	NCE30NP1812K	TO-252-4L	-	-	-

### Absolute Maximum Ratings (T<sub>A</sub>=25℃ unless otherwise noted)

Parameter		Symbol	N-Channel	P-Channel	Unit	
Drain-Source Voltage		V <sub>DS</sub>	30	-30	V	
Gate-Source Voltage		V <sub>GS</sub>	±12	±12	V	
	T <sub>A</sub> =25℃		18	-12	•	
Continuous Drain Current	T <sub>A</sub> =70℃	ID	14.4	-8.5	A	
Pulsed Drain Current (Note 1)		I <sub>DM</sub>	72	-48	А	
Maximum Power Dissipation	T <sub>A</sub> =25℃	PD	25	25	W	
Operating Junction and Storage Temperature Range		TJ,TSTG	-55 To 150	-55 To 150	°C	

### **Thermal Characteristic**

Thermal Resistance, Junction-to-Case (Note2)	R <sub>ejc</sub>	N-Ch	5	°C/W
Thermal Resistance, Junction-to-Case <sup>(Note2)</sup>	$R_{ extsf{ heta}JC}$	P-Ch	5	°C/W



# N-CH Electrical Characteristics (T\_A=25 $^\circ\!\!\mathrm{C}$ unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Мах	Unit
\Off Characteristics	·····			•		
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250µA	30	-	-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =30V,V <sub>GS</sub> =0V	-	-	1	μΑ
Gate-Body Leakage Current	I <sub>GSS</sub>	$V_{GS}$ =±20V, $V_{DS}$ =0V	-	-	±100	nA
On Characteristics (Note 3)	·			•		
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS}=V_{GS}$ , $I_{D}=250\mu A$	1	1.5	2.0	V
Durain Courses On State Desistance	P	$V_{GS}$ =10V, $I_{D}$ =10A	-	36	41	mΩ
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =4.5V, I <sub>D</sub> =10A	-	45	54	mΩ
Forward Transconductance	<b>g</b> fs	V <sub>DS</sub> =5V,I <sub>D</sub> =10A		10	-	S
Dynamic Characteristics (Note4)	·			•		
Input Capacitance	C <sub>lss</sub>		-	519.9	-	PF
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> =15V,V <sub>GS</sub> =0V, F=1.0MHz	-	55.5	-	PF
Reverse Transfer Capacitance	C <sub>rss</sub>		-	49.3	-	PF
Switching Characteristics (Note 4)	·			•		
Turn-on Delay Time	t <sub>d(on)</sub>		-	5	-	nS
Turn-on Rise Time	tr	$V_{DD}$ =15V, R <sub>L</sub> =1.5 $\Omega$	-	3	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{GS}$ =10V, $R_{GEN}$ =3 $\Omega$	-	15	-	nS
Turn-Off Fall Time	t <sub>f</sub>		-	3	-	nS
Total Gate Charge	Qg		-	14.7	-	nC
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}$ =15V,I <sub>D</sub> =10A,	-	2.5	-	nC
Gate-Drain Charge	Q <sub>gd</sub>	V <sub>GS</sub> =10V	-	3.0	_	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =10A	-	0.8	1.2	V



### P-CH Electrical Characteristics (T<sub>A</sub>=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =-250µA	-30	-	-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS}$ =-30V, $V_{GS}$ =0V	-	-	-1	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	$V_{GS}$ =±20V, $V_{DS}$ =0V	-	-	±100	nA
On Characteristics (Note 3)			•			
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$ , $I_{D}=-250\mu A$	-1.0	-1.5	-2.0	V
Desia Oscara Os Otata Dasistanas		V <sub>GS</sub> =-10V, I <sub>D</sub> =-12A	-	50	58	mΩ
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	$V_{GS}$ =-4.5V, I <sub>D</sub> =-10A	-	71	85	mΩ
Forward Transconductance	<b>g</b> fs	V <sub>DS</sub> =-5V,I <sub>D</sub> =-12A	-	10	-	S
Dynamic Characteristics (Note4)			1			
Input Capacitance	C <sub>lss</sub>		-	464.7	-	PF
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> =-15V,V <sub>GS</sub> =0V, F=1.0MHz	-	70.4	-	PF
Reverse Transfer Capacitance	C <sub>rss</sub>		-	53.8	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t <sub>d(on)</sub>		-	5	-	nS
Turn-on Rise Time	t <sub>r</sub>	$V_{DD}$ =-15V, R <sub>L</sub> =1.25 $\Omega$	-	3	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{GS}$ =-10V, $R_{GEN}$ =6 $\Omega$	-	15	-	nS
Turn-Off Fall Time	t <sub>f</sub>		-	4	-	nS
Total Gate Charge	Qg		-	12.6	-	nC
Gate-Source Charge	Q <sub>gs</sub>	V <sub>DS</sub> =-15V,I <sub>D</sub> =-12A V <sub>GS</sub> =-10V	-	2.1	-	nC
Gate-Drain Charge	Q <sub>gd</sub>	V <sub>GS</sub> =-10V	-	3.0	-	nC
Drain-Source Diode Characteristics	<b>I</b>					
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =-12A	-	-	-1.2	V

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.

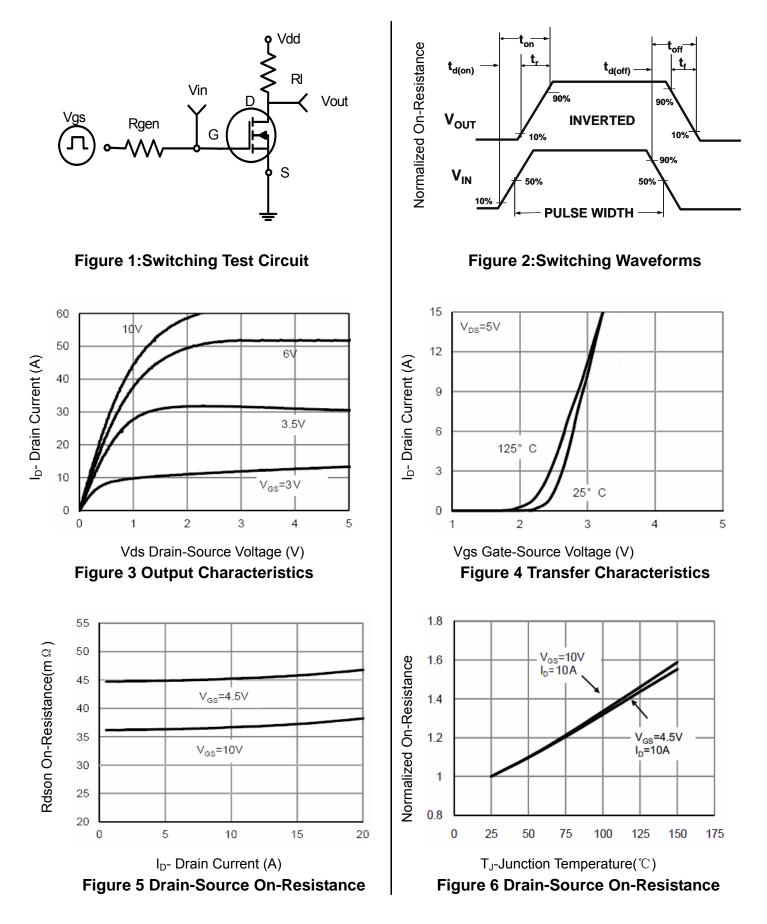
**2.** Surface Mounted on FR4 Board,  $t \le 10$  sec.

**3.** Pulse Test: Pulse Width  $\leq$  300µs, Duty Cycle  $\leq$  2%.

4. Guaranteed by design, not subject to production

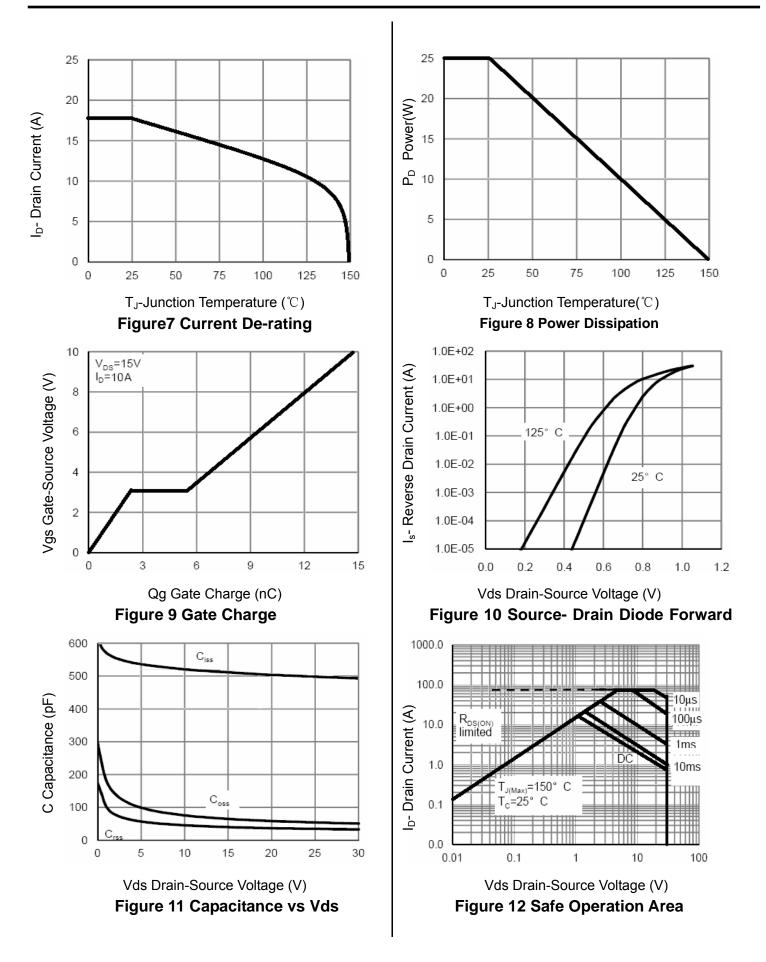


### N- Channel Typical Electrical and Thermal Characteristics (Curves)





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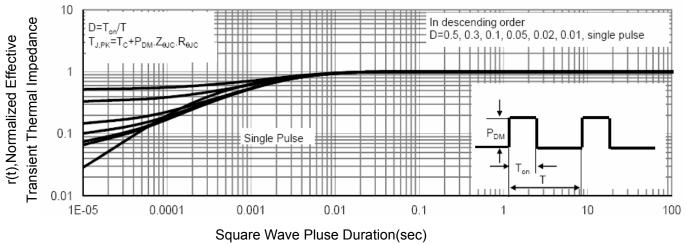
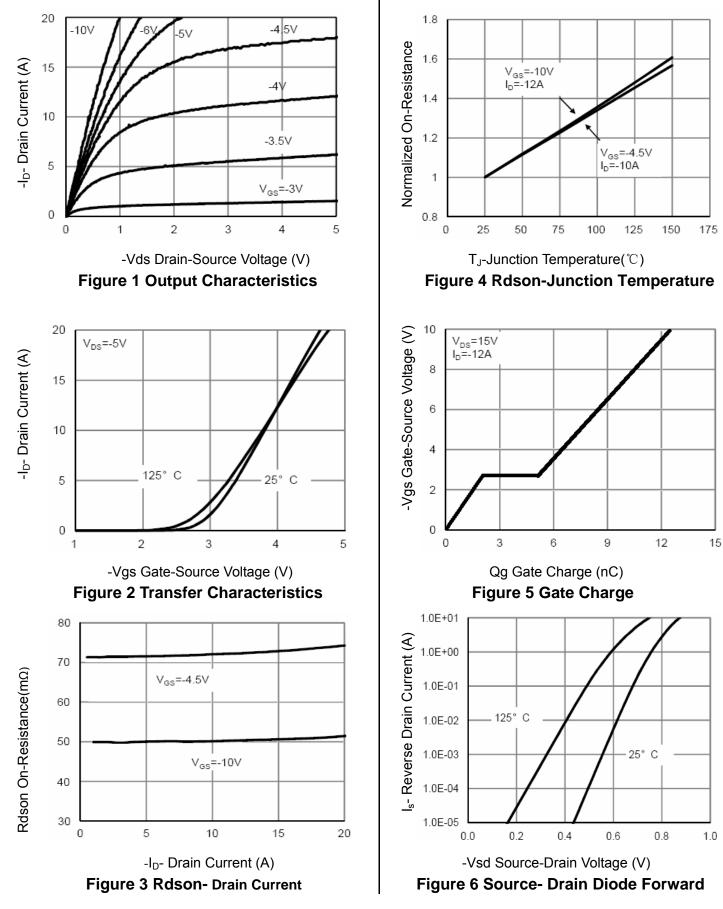


Figure 13 Normalized Maximum Transient Thermal Impedance

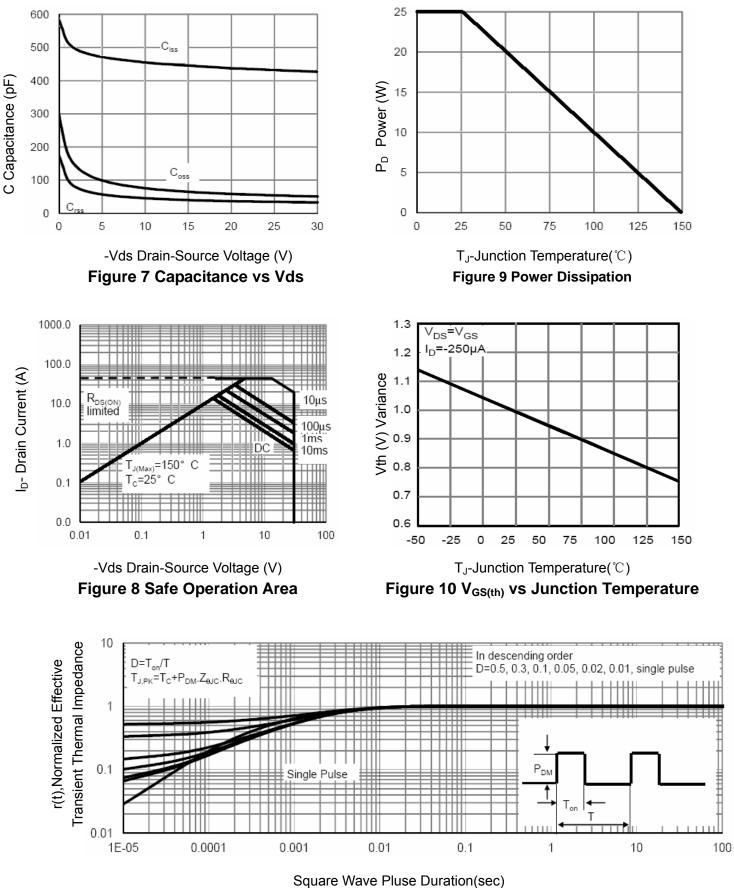


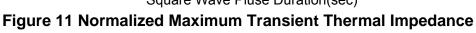
### P- Channel Typical Electrical and Thermal Characteristics (Curves)





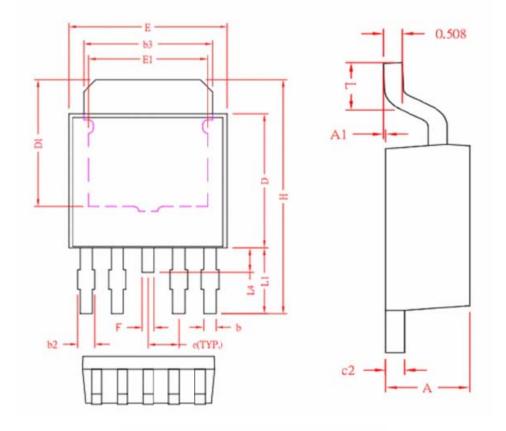
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# TO-252-4L Package Information



(UNITS	OF MEAS	URE=MILL	IMETER)		
SYMBOL	MIN	NOM	MAX		
A	2.20	2.30	2.40		
A1	0	0.08	0.15		
b	0.45	0.53	0.60		
b2	0.50	0.65	0.80		
b3	5.20	5.35	5.50		
c2	0.45	0.50	0.55		
D	5.40	5.60	5.80		
D1	4.57		-		
E	6.40	6.60	6.80		
E1	3.81	-			
е	1.27 REF.				
F	0.40	0.50	0.60		
H	9.40	9.80	10.20		
L	1.40	1.59	1.77		
L1	2.40	2.70	3.00		
L4	0.80	1.00	1.20		

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